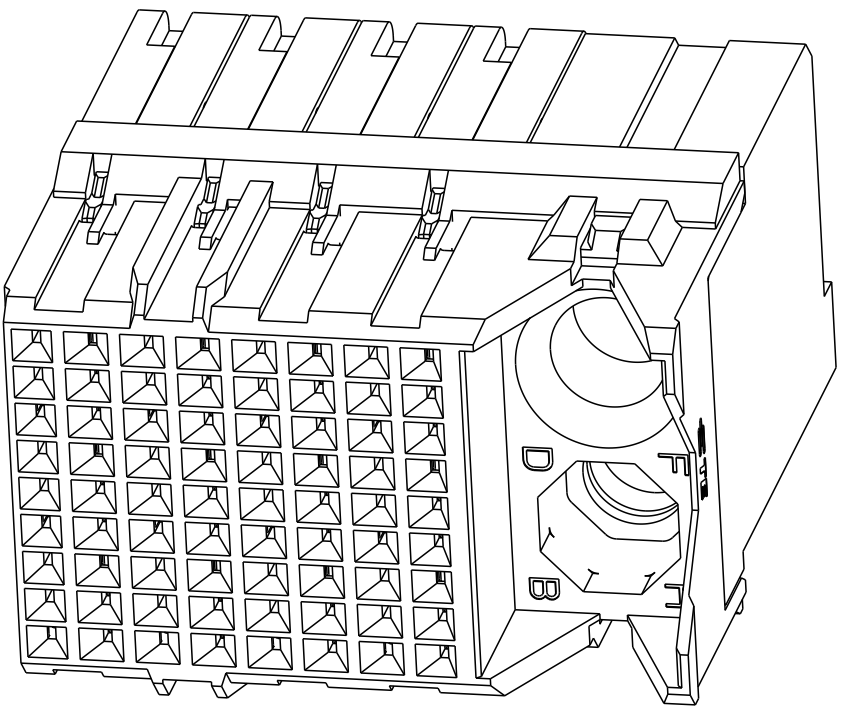


LOC		DIST		REVISIONS					
AD	00	P	LTR	DESCRIPTION		DATE	DWN	APVD	
		G1		REVISED PER ECO-14-018035		11MAR2015	AP	DD	
		G2		PLATING DETAILS UPDATED		24JUL2025	CR	PV	

1 MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.

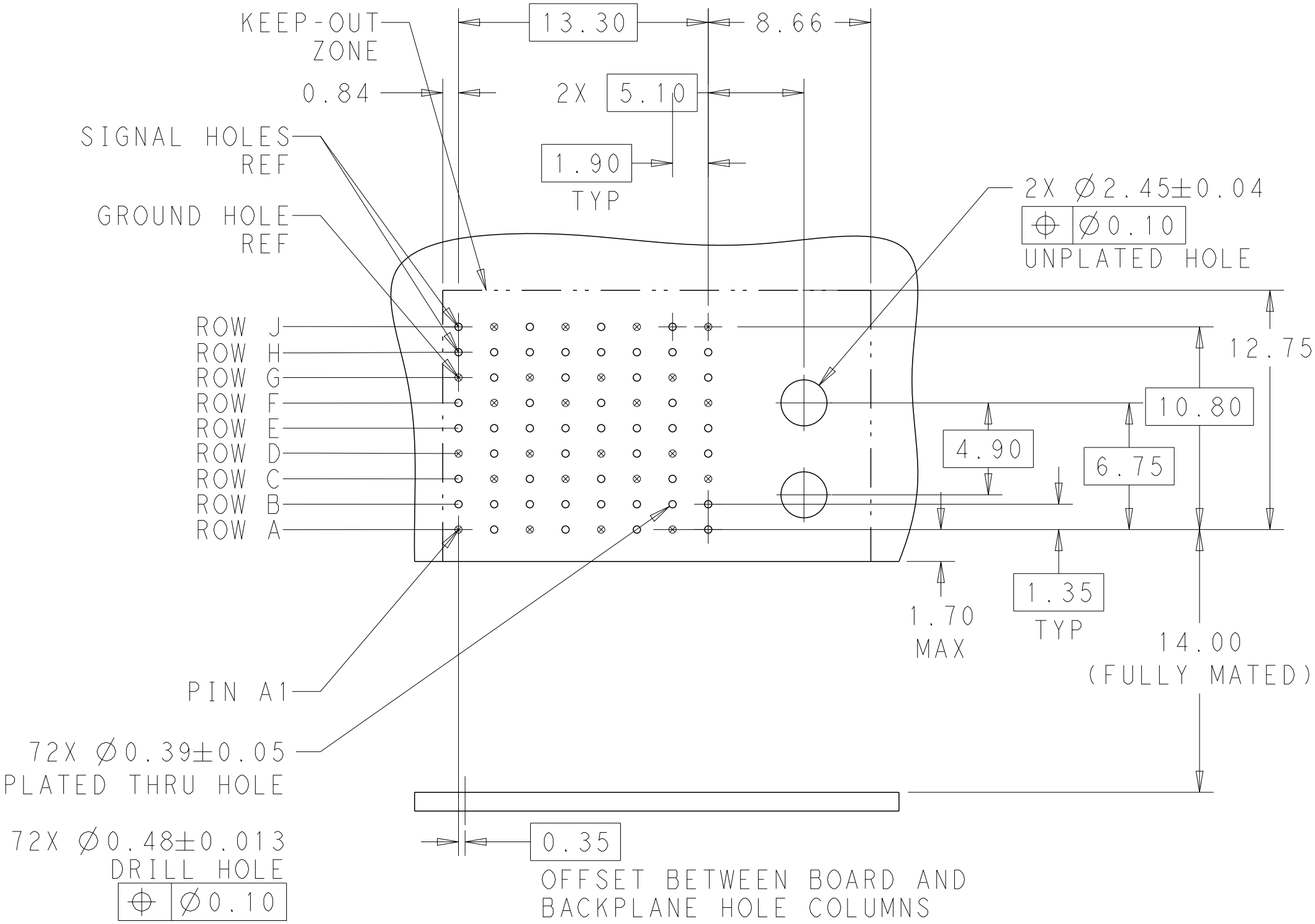
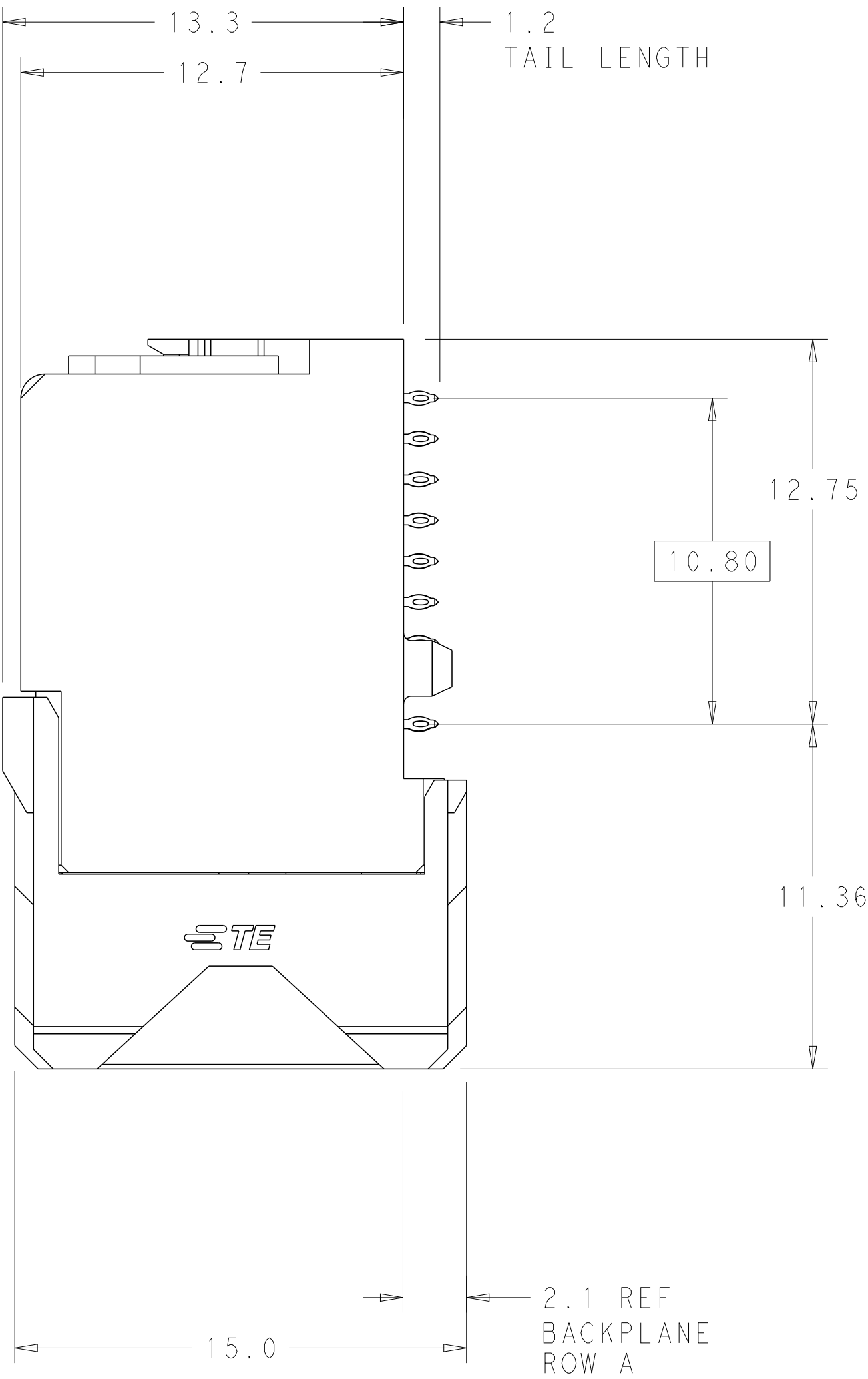
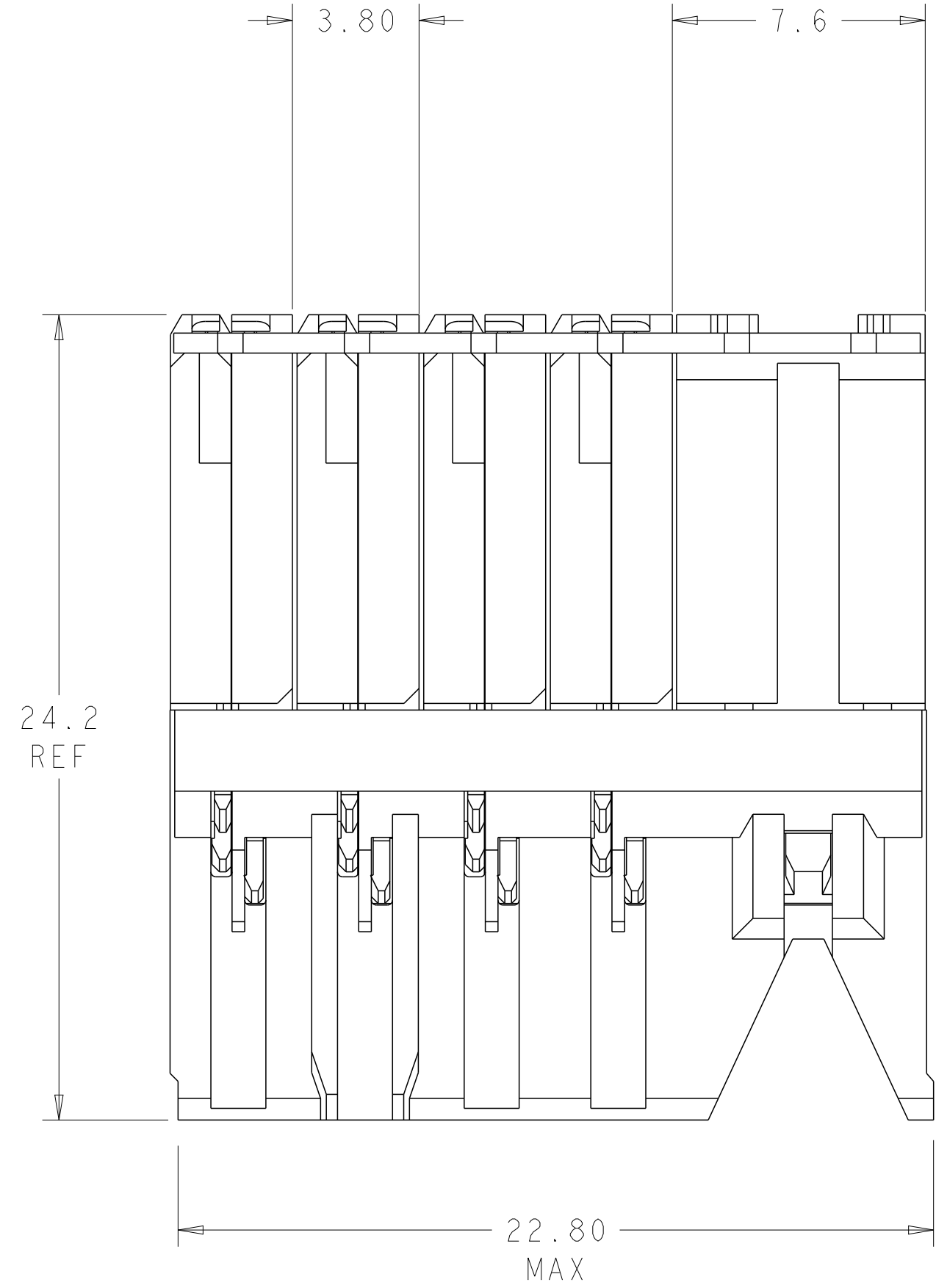
62 2 FINISH:
30µ" SELECTIVE GOLD OR OR GOLD FLASH OVER PALLADIUM
NICKEL (PdNi) PLATING IN CONTACT AREA. SELECTIVE TIN
ON PCB TAILS, NICKEL OVERALL.

3. CONNECTORS SUPPLIED WITH MOUNTING SCREW.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY



KEY POSITION CHART	
	NONE
	A
	B
	C
	D
	E
	F
	G
	H

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

H	2	8-2057692-1
G	2	7-2057692-1
F	2	6-2057692-1
E	2	5-2057692-1
D	2	4-2057692-1
C	2	3-2057692-1
B	2	2-2057692-1
A	2	1-2057692-1
NONE	2	2057692-1
KEY POSITION		PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN D. HUMBERT 04FEB2011		 TE Connectivity	
DIMENSIONS:		CHK D. DIXON 04FEB2011			
mm		APVD D. DIXON 04FEB2011			
		PRODUCT SPEC			
		P L C 1 P L C 2 P L C 3 P L C 4 P L C ANGLES FINISH		NAME IMPACT, 3 PAIR, DAUGHTERCARD 8 COLUMN, RIGHT GUIDED, SIGNAL MODULE, 0.39 EYELET	
MATERIAL 		SEE TABLE		SIZE A100779	
				CAGE CODE =2057692	
				RESTRICTED TO	
				SCALE 6:1	
				SHEET 1 OF 1	
				REV G2	